

# PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT										
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT										
<b>CONVEYING PARTY DATA</b>											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>William H. Dietz</td> <td>10/22/2010</td> </tr> <tr> <td>Kenneth A. Cupples</td> <td>10/22/2010</td> </tr> <tr> <td>Richard W. Schlueter</td> <td>10/27/2010</td> </tr> </tbody> </table>		Name	Execution Date	William H. Dietz	10/22/2010	Kenneth A. Cupples	10/22/2010	Richard W. Schlueter	10/27/2010		
Name	Execution Date										
William H. Dietz	10/22/2010										
Kenneth A. Cupples	10/22/2010										
Richard W. Schlueter	10/27/2010										
<b>RECEIVING PARTY DATA</b>											
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;"><b>Name:</b></td> <td>Ortronics, Inc.</td> </tr> <tr> <td><b>Street Address:</b></td> <td>125 Eugene O'Neill Drive</td> </tr> <tr> <td><b>City:</b></td> <td>New London</td> </tr> <tr> <td><b>State/Country:</b></td> <td>CONNECTICUT</td> </tr> <tr> <td><b>Postal Code:</b></td> <td>06320</td> </tr> </table>		<b>Name:</b>	Ortronics, Inc.	<b>Street Address:</b>	125 Eugene O'Neill Drive	<b>City:</b>	New London	<b>State/Country:</b>	CONNECTICUT	<b>Postal Code:</b>	06320
<b>Name:</b>	Ortronics, Inc.										
<b>Street Address:</b>	125 Eugene O'Neill Drive										
<b>City:</b>	New London										
<b>State/Country:</b>	CONNECTICUT										
<b>Postal Code:</b>	06320										
<b>PROPERTY NUMBERS Total: 1</b>											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12889996</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12889996						
Property Type	Number										
Application Number:	12889996										
<b>CORRESPONDENCE DATA</b>											
<p>Fax Number: (203)399-5822</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 203-399-5920</p> <p>Email: jsimmons@mccarter.com</p> <p>Correspondent Name: McCarter &amp; English, LLP</p> <p>Address Line 1: Canterbury Green</p> <p>Address Line 2: 201 Broad Street, 9th Floor</p> <p>Address Line 4: Stamford, CONNECTICUT 06901</p>											
<b>ATTORNEY DOCKET NUMBER:</b>	97895.00295										
<b>NAME OF SUBMITTER:</b>	Basam E. Nabulsi										
<p>Total Attachments: 2</p> <p>source=ORTRONICS .00295 ASSIGNMENT#page1.tif</p>											

CH \$40.00 12889996

**501336741**

**PATENT**  
**REEL: 025224 FRAME: 0916**



**ASSIGNMENT**

For good and valuable consideration, the receipt of which is hereby acknowledged,  
I the undersigned,

William Dietz, 17 Sunset Hill Drive, Branford, CT 06405
---

Kenneth A. Cupples, 11 Miner Pentway, Pawcatuck, CT 06379
---

Richard W. Schlueter, 84 High Street, Clinton, CT 06413
---

*(insert full name(s) and post office addresses of inventors)*

(hereinafter, "Assignor"), who has created a certain invention for which an  
application for United States Letters Patent entitled:

**HIGH DENSITY JACK**

*(insert title of invention)*

*(check one)*

- ☐ for which the application is attached hereto; or
- ☒ for which the application for U.S. Letters Patent has been filed on  
September 24, 2010, as Application Serial No. 12/889,996.

Do hereby sell, assign and transfer to:

Ortronics, Inc., 125 Eugene O'Neill Drive, New London, CT 06320

*(insert full name(s) and post office addresses of assignee)*

(hereinafter, "Assignee"), its successors, assigns, and legal representatives, the  
full and exclusive right to said invention and said application and to any and all  
inventions described in said application for the United States, its territorial  
possessions and all foreign countries, and the entire right, title and interest in and  
to any and all Letters Patent which may be granted therefor in the United States,  
its territorial possessions and all foreign countries; and in and to any and all  
continuations-in-part, continuations, divisions, substitutes, reissues, extensions  
thereof, and all other applications for Letters Patent relating thereto which have  
been or shall be filed in the United States, its territorial possessions and/or any  
foreign countries, and all rights, together with all priority rights, under any of the  
international conventions, unions, agreements, acts, and treaties, including all  
future conventions, unions, agreements, acts, and treaties;

I authorize Assignee to apply for and receive Letters Patent for such protection in  
its own name, in the United States, its territorial possessions, and all foreign  
countries; and that, when requested to carry out in good faith the intent and

purpose of this assignment, at the expense of said Assignee, but without charge to Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, and extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

IN TESTIMONY WHEREOF, I have hereunto set my signature below.

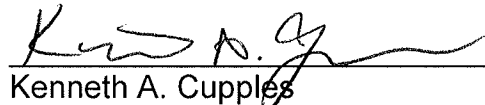
**Signature of inventor:**

Date: 10/22/10

  
William H. Dietz

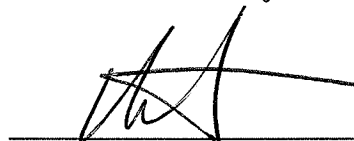
**Signature of inventor:**

Date: 10/22/10

  
Kenneth A. Cupples

**Signature of inventor:**

Date: 10/27/10

  
Richard W. Schlueter